

CRMDTL138K N-Channel 60V, 1.7Ω Typ. Power MOSFET

Description

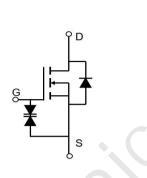
Features

• 60V, 0.2A

 $R_{DS(ON)}$ Typ = 1.7 Ω @ V_{GS} = 10V

 $R_{DS(ON)}$ Typ = 1.9 Ω @ V_{GS} = 4.5V

- Advanced Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- Lead Free
- ESD Protected: 2KV



Schematic Diagram

Application

- Load Switch
- PWM Application
- Power Management

Marking and Pin Assignment

L138K

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMDTL138K	L138K	DFN1006-3L	TAPING	7"	10000	400000

D

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V _{DS}	Drain-to-Source Voltage		60	V
V _{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Current		А	
Ι _D		T _A = 100°C	0.12	А
I _{DM}	Pulsed Drain Current ⁽¹⁾		0.8	А
P _D	Power Dissipation	T _A = 25°C	0.15	W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Case $^{(2)}$		835	°C/W
Τ _J , Τ _{stg}	Junction & Storage Temperature Range		-55 to 150	°C



Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Chara	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_{\rm D}$ = 250 μ A, V _{GS} = 0V	60	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 60V, V _{GS} = 0V	-	-	1.0	μA
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±10	μΑ
On Chara	acteristics				6	
V _{GS(th)}	Gate Threshold Voltage	V_{DS} = V_{GS} , I_D = 250 μ A	0.7	1.2	1.5	V
R _{DS(ON)}	(3)	V _{GS} = 10V, I _D = 0.2A	-	1.7	2	Ω
	Static Drain-Source ON-Resistance ⁽³⁾	V _{GS} = 4.5V, I _D = 0.1A	-	1.9	2.3	Ω
Dynamic	Characteristics					
C _{iss}	Input Capacitance		-	22	-	pF
C _{oss}	Output Capacitance	V _{GS} = 0V, V _{DS} = 25V, f = 1MHz	Χ-	3.4	-	pF
C _{rss}	Reverse Transfer Capacitance		\mathbf{C}	2.3	-	pF
Q _g	Total Gate Charge	0	V.	1.6	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0 \text{ to } 4.5V$ $V_{DS} = 10V, I_D = 0.2A$) -	0.2	-	nC
Q_{gd}	Gate Drain("Miller") Charge	$v_{\rm DS} = 100, n_{\rm D} = 0.2A$	-	0.5	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime		-	2	-	ns
t _r	Turn-On Rise Time	V _{GS} = 10V, V _{DD} = 10V	-	14	-	ns
$t_{d(off)}$	Turn-Off DelayTime	I_{D} = 0.2A, R_{GEN} = 10 Ω	-	6	-	ns
t _f	Turn-Off Fall Time		-	19	-	ns
Drain-So	urce Diode Characteristics and N	lax Ratings				
I _S	Maximum Continuous Drain to Source Die	-	-	0.2	А	
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	0.8	А
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 0.2A	-	-	1.2	V
Notes:	1. Repetitive Rating: Pulse Width Limited by Maxim	um Junction Temperature.				

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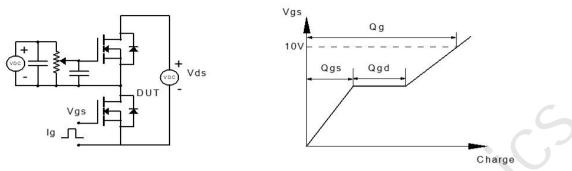
2. $R_{\theta JA}$ is measured with the device mounted on a 1inch² pad of 2oz copper FR4 PCB

3. Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.



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Test Circuit





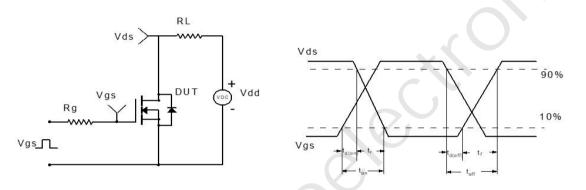


Figure 2: Resistive Switching Test Circuit & Waveform

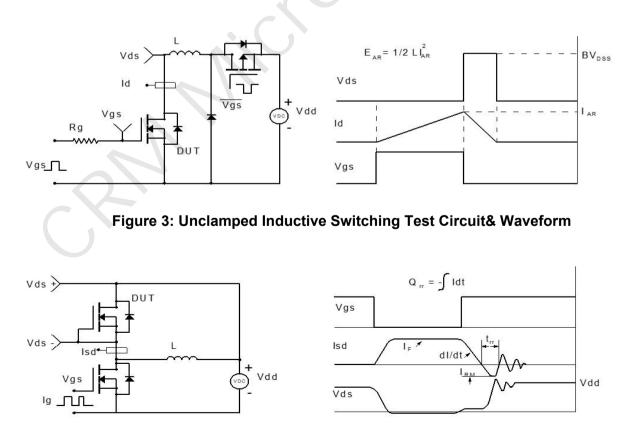
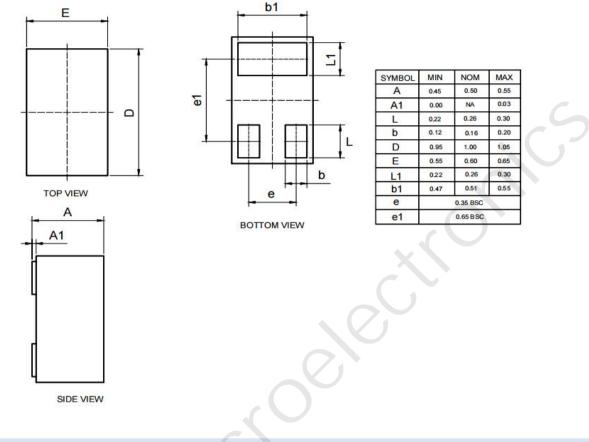


Figure 4: Diode Recovery Test Circuit & Waveform



Package Mechanical Data(DFN1006-3L)



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